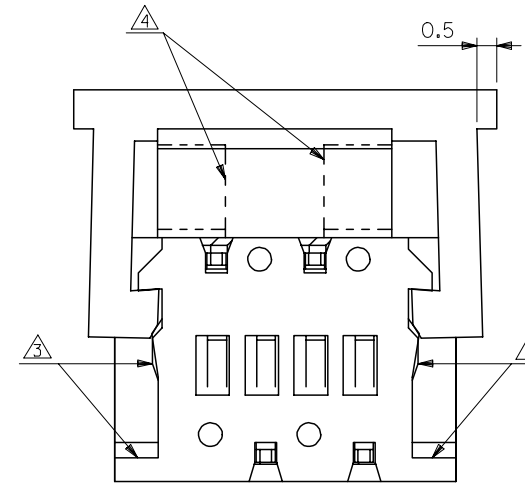
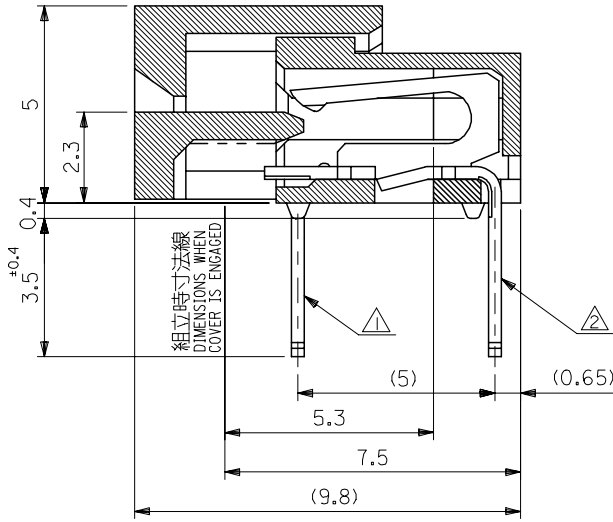
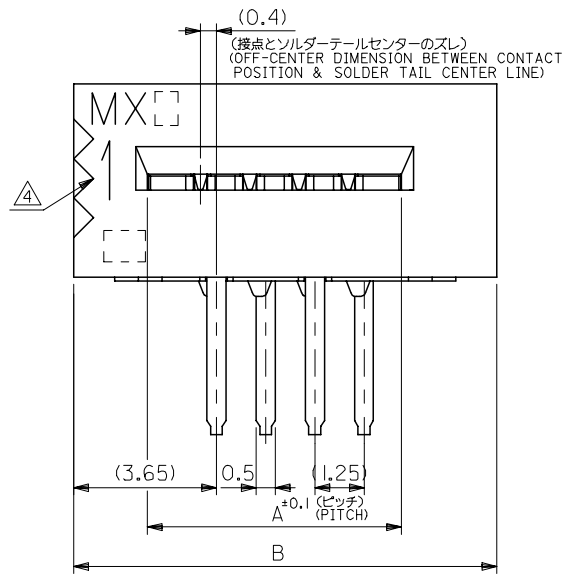


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注記 NOTES

- △ MX J側を基準に奇数番目の極におけるソルダーテール。
SOLDER TAIL OF ODD CKTS, MXJ MARK AS BASIC.
- △ MX J側を基準に偶数番目の極におけるソルダーテール。
SOLDER TAIL OF EVEN CKTS, MXJ MARK AS BASIC.
- △ 3極～10極に適用。APPLY FOR 3-10 CKTS.
- △ 3極～19極に適用。APPLY FOR 3-19 CKTS.
- 5. () 内寸法は、参考値。
() DIMENSION IS FOR REFERENCE.
- 6. ソルダーテールは、先端が取付推奨穴にガイドされること。
SOLDER TAILS MAY BE CHECKED BY INSERTION FOR RECOMMENDED PCB BOARD HOLES.
- 7. 本製品は5597-NAPBの鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 5597-NAPB.

48.25	43.95	39-53-2344	5597-34APB7F	34
47.00	42.70	-2334	-33APB7F	33
45.75	41.45	-2324	-32APB7F	32
44.50	40.20	-2314	-31APB7F	31
43.25	38.95	-2304	-30APB7F	30
42.00	37.70	-2294	-29APB7F	29
40.75	36.45	-2284	-28APB7F	28
39.50	35.20	-2274	-27APB7F	27
38.25	33.95	-2264	-26APB7F	26
37.00	32.70	-2254	-25APB7F	25
35.75	31.45	-2244	-24APB7F	24
34.50	30.20	-2234	-23APB7F	23
33.25	28.95	-2224	-22APB7F	22
32.00	27.70	-2214	-21APB7F	21
30.75	26.45	-2204	-20APB7F	20
29.50	25.20	-2194	-19APB7F	19
28.25	23.95	-2184	-18APB7F	18
27.00	22.70	-2174	-17APB7F	17
25.75	21.45	-2164	-16APB7F	16
24.50	20.20	-2154	-15APB7F	15
23.25	18.95	-2144	-14APB7F	14
22.00	17.70	-2134	-13APB7F	13
20.75	16.45	-2124	-12APB7F	12
19.50	15.20	-2114	-11APB7F	11
18.25	13.95	-2104	-10APB7F	10
17.00	12.70	-2094	-09APB7F	9
15.75	11.45	-2084	-08APB7F	8
14.50	10.20	-2074	-07APB7F	7
13.25	8.95	-2064	-06APB7F	6
12.00	7.70	-2054	-05APB7F	5
10.75	6.45	-2044	-04APB7F	4
9.50	5.20	39-53-2034	5597-03APB7F	3
B	A	EDP NO.	ENG NO.	極数 CKT.

材料 MATERIAL	HOUSING, ACTUATOR : PBTP, UL94V-0
TERMINAL : PHOSPHOR-BRONZE	THK : 0.3t
仕上げ FINISH	TIN-BISMUTH : 10 MICROMETER MINIMUM
OVER NICKEL PLATING :	10 MICROMETER MINIMUM
適用電線範囲 WIRE RANGE	— # —
被覆外径 INS. RANGE	— # —

REVISED	EC NO: J2007-2876	2007/04/19	DRW:KSAIT001	2007/04/19	CHKD:THARUYAMA	2007/04/19	APPR:NUKITA	2007/04/20	DESCRIPTION
B									GENERAL TOLERANCES (UNLESS SPECIFIED)
10 UNDER		±0.2		DRAWN BY		DATE		TITLE	
10 OVER 30 UNDER		±0.25		M. NAGATA		'04/05/10		1.25 FPC CONNECTOR	
30 OVER		±0.3		CHECKED BY		DATE		ASSY ZIF	
ANGULAR		±3 °		K. TOJO		'04/05/10		-LEAD FREE-	
DRAFT WHERE APPLICABLE		MUST REMAIN		APPROVED BY		DATE		MOLEX INCORPORATED	
WITHIN DIMENSIONS				M. SASAO		'04/05/10		MOLEX INCORPORATED	
SIZE		A3		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
				SEE CHART		SD-5597-011		1 OF 2	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

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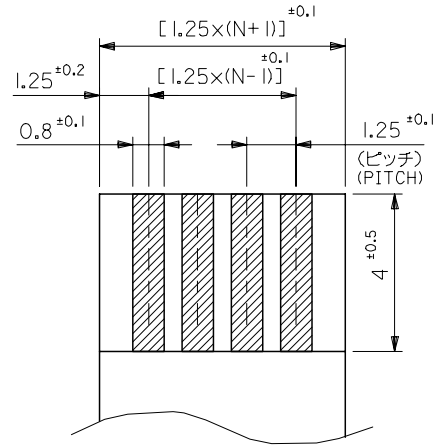
E

D

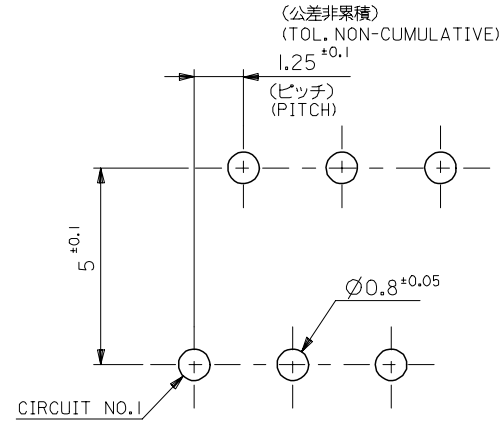
C

B

A



適合FPC/FFC推奨寸法
RECOMMENDED FPC/FFC
厚さ THK : 0.3^{±0.05}



基板取付穴推奨寸法 (t=1.6)
RECOMMENDED P.C. BOARD
HOLE DIMENSION

FPC/FFCについて:

打抜き方向は導体側から補強板側を推奨いたします。
導体部については軟銅箔35マイクロメートルまたは50マイクロメートルを推奨いたします。

ABOUT FPC/FFC

RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER FILM SIDE.
RECOMMENDED CONDUCTOR SPEC :
THICKNESS OF SOFT COPPER FOIL : 35 MICROMETER OR 50 MICROMETER.

FPCについて:

補強フィルム材質はポリイミドを推奨します。
接着剤は熱硬化接着剤を推奨します。

ABOUT FPC

RECOMMENDED MATERIAL :
STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT

MODEL NO. 5597-NAPB7F

REVISED EC NO: J2007-2876 DRWN:KSAIT001 2007/04/19 CHKD:THARUYAMA 2007/04/19 APPR:NUKITA 2007/04/20	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	± 0.2	DRAWN BY M. NAGATA	DATE '04/05/10	TITLE 1.25 FPC CONNECTOR ASSY ZIF -LEAD FREE-			
	10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOJO	DATE '04/05/10	MOLEX INCORPORATED			
	30 OVER	± 0.3	APPROVED BY M. SASAO	DATE '04/05/10	DOCUMENT NO. SD-5597-011		SHEET NO. 2 OF 2	
	ANGULAR	± 3 °	MATERIAL NO. SEE CHART					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

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